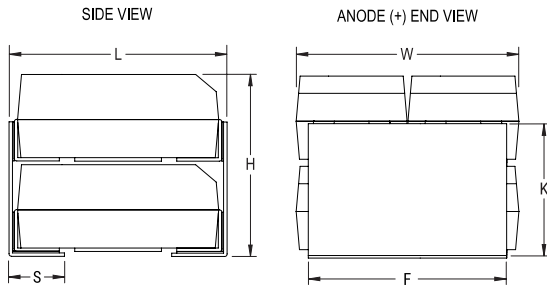


TSP, Tantalum, Polymer Tantalum, HRA, 260 uF, 20%, 25 VDC, 4X



General Information	
Series:	TSP
Dielectric:	Polymer Tantalum
Style:	Stacked Chip
Description:	SMD, Polymer, KO, Stacks, High Reliability
Features:	High Reliability
RoHS:	Yes
Termination:	Tin
Termination (Stack):	Tin
AEC-Q200:	No
MSL:	3

Dimensions	
Case Code	4X
L	8mm +/-0.38mm
W	8.9mm +/-0.2mm
H	8.9mm +/-0.38mm
S	1.9mm +/-0.38mm
F	7.4mm +/-0.2mm
K	6.9mm +/-0.38mm

Specifications	
Capacitance:	260 uF
Capacitance Tolerance:	20%
Voltage DC:	25 VDC (105C), 16.75 VDC (125C)
Temperature Range:	-55/+125°C
Rated Temperature:	105°C
Dissipation Factor:	10% 120Hz 25C
Failure Rate:	N/A
Resistance:	12 mOhms (100kHz 25C)
Leakage Current:	650 uA (5min 25°C)
Testing and Reliability:	4 Cycles At +25C +/-5C Before Voltage Aging

Packaging Specifications	
Packaging:	Tray
Packaging Quantity:	50

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

单击下面可查看定价，库存，交付和生命周期等信息

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